Silicon Carbide Schottky Diode



VRRM =	650 V
F (Tc = 141°C) =	30 A
Qc =	46 nC

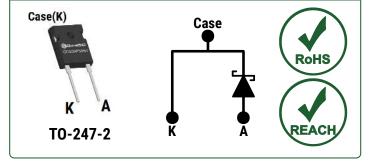
Features

- Gen4 Thin Chip Technology for Low V_{F}
- Superior Power Efficiency
- Superior Figure of Merit Q_C/I_F
- Enhanced Surge Current Robustness
- Low Thermal Resistance
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of VF
- High dV/dt Ruggedness

Advantages

- Optimal Price Performance
- Improved System Efficiency
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- High System Reliability
- Easy to Parallel without Thermal Runaway
- Enables Extremely Fast Switching

Package



Applications

- Power Factor Correction (PFC)
- Electric Vehicles and Battery Chargers
- Solar Inverters
- High Frequency Converters
- Switched Mode Power Supply (SMPS)
- Motor Drives
- Anti-Parallel / Free-Wheeling Diode
- Induction Heating & Welding

Absolute Maximum Ratings (At T_c = 25°C Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V _{RRM}		650	V	
		T _C = 100°C, D = 1	49		
Continuous Forward Current	IF	T _C = 135°C, D = 1	33	А	Fig. 4
		T _C = 141°C, D = 1	30		
Non-Repetitive Peak Forward Surge Current, Half Sine	Irou	T _C = 25°C, t _P = 10 ms	210	٨	
lave	I _{F,SM}	Tc = 150°C, t⊵ = 10 ms	168	A	
epetitive Peak Forward Surge Current, Half Sine Wave	lenu	T _C = 25°C, t _P = 10 ms	126	Α	
	I _{F,RM}	Tc = 150°C, t⊵ = 10 ms	89	A	
Non-Repetitive Peak Forward Surge Current	I _{F,MAX}	T _C = 25°C, t _P = 10 μs	1050	Α	
i ² t Value	∫i²dt	T _C = 25°C, t _P = 10 ms	220	A ² s	
Non-Repetitive Avalanche Energy	E _{AS}	L = 0.6 mH, I _{AS} = 30 A	276	mJ	
Diode Ruggedness	dV/dt	V _R = 0 ~ 520 V	200	V/ns	
Power Dissipation	Ртот	T _C = 25°C	237	W	Fig. 3
Operating and Storage Temperature	T _j , T _{stg}		-55 to 175	°C	

GD30MPS06H 650V 30A SiC Schottky MPS™ Diode



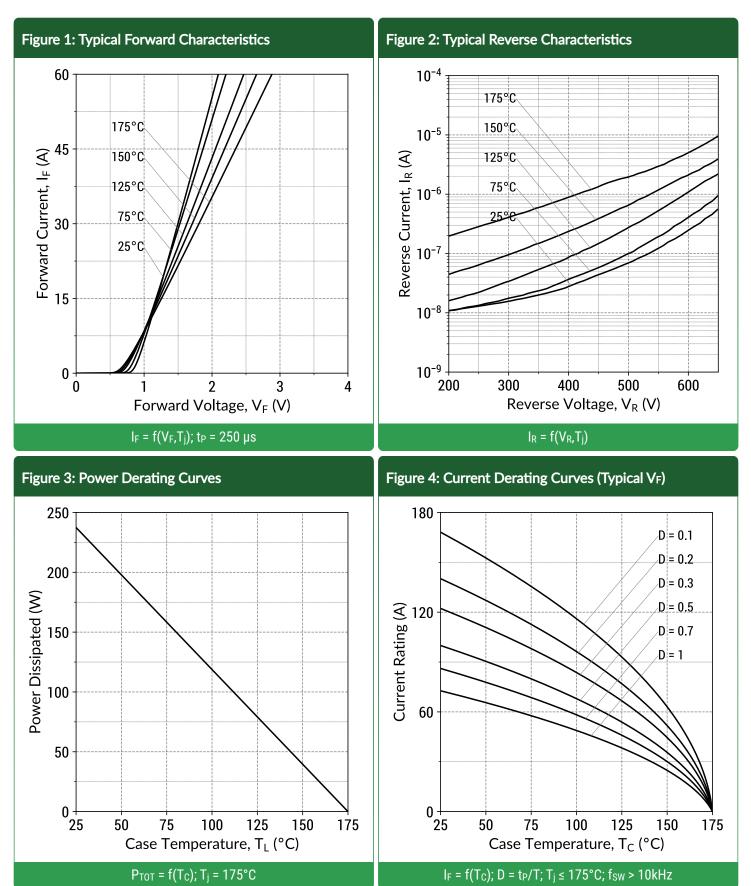
Electrical Characteristics

Parameter	Symbol	Conditions		Values			Unit	Note
Palallelel	Symbol			Min.	Тур.	Max.	Unit	Note
Diode Forward Voltage	V _F	I _F = 30 A, T _j = 25°C			1.5	1.8	V	Fig. 1
blode Forward voltage	۷F	I _F = 30 A, T _j = 175°C			1.8			
Reverse Current	I-	V _R = 650 V, T	j = 25°C		1	5		Fig. 2
Reverse current	I _R	V _R = 650 V, T _j = 175°C			6		μA	FIY. Z
Total Consoitive Charge	0-		V _R = 200 V		31		nC	Fig. 7
Total Capacitive Charge	Qc	I _F ≤ I _{F,MAX}	V _R = 400 V		46			
Quitabing Time	+	dl _F /dt = 200 A/µs	V _R = 200 V		. 10			
Switching Time	ts		V _R = 400 V		< 10		ns	
Tatal Canaditanaa	0	V _R = 1 V, f =	1MHz		735		" Г	Fig. 6
Total Capacitance	С	V _R = 400 V, f = 1MHz			63		pF	Fig. 6

Thermal/Package Characteristics

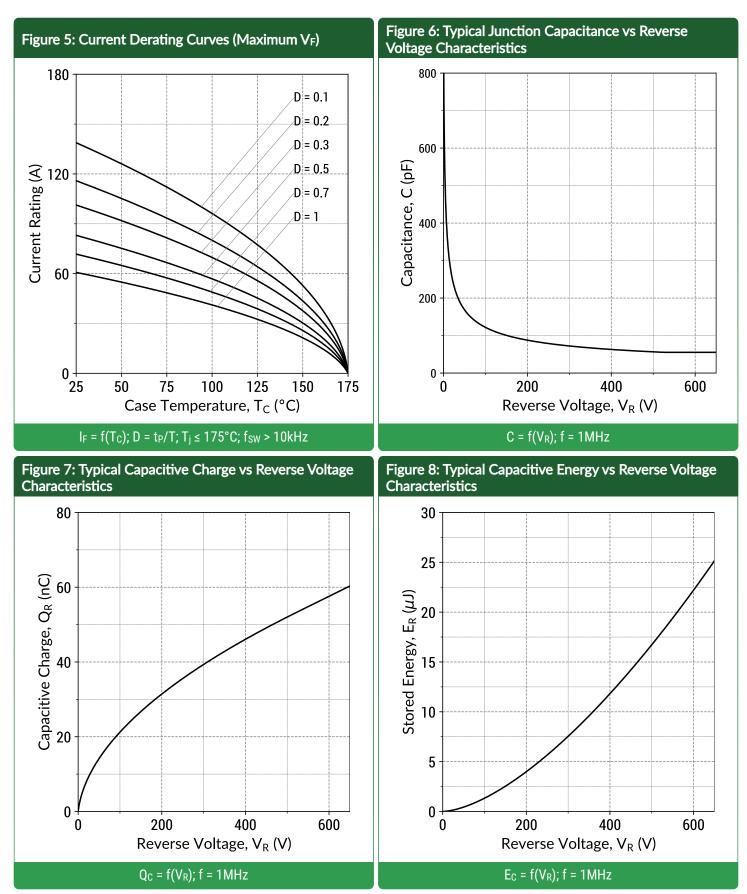
Parameter	Symbol	Conditions		Values		Unit	Note
Parallieler	Symbol	Conultions	Min.	Typ.	Max.	Unit	Note
Thermal Resistance, Junction - Case	RthJC			0.63		°C/W	Fig. 9
Weight	WT			6.0		g	
Mounting Torque	T _M	Screws to Heatsink			1.1	Nm	





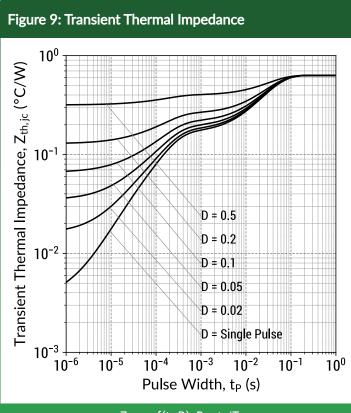
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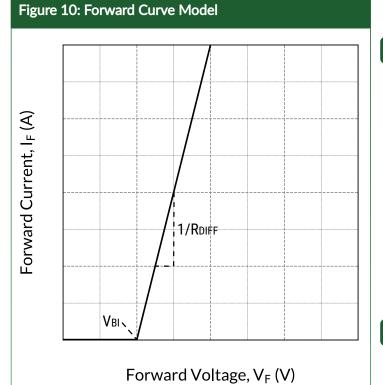


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 $Z_{th,jc} = f(t_P,D); D = t_P/T$



 $I_F = f(V_F, T_j)$

Forward Curve Model Equation:

 $I_F = (V_F - V_{BI})/R_{DIFF} (A)$

Built-In Voltage (V_{BI}):

 $V_{BI}(T_j) = m \times T_j + n (V)$ m = -0.00115 (V/°C) n = 9.31e-01 (V)

Differential Resistance (RDIFF):

 $R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c (\Omega)$ a = 5.07e-07 (\Omega/\circ C^2) b = 5.5e-06 (\Omega/\circ C) c = 0.0194 (\Omega)

Forward Power Loss Equation:

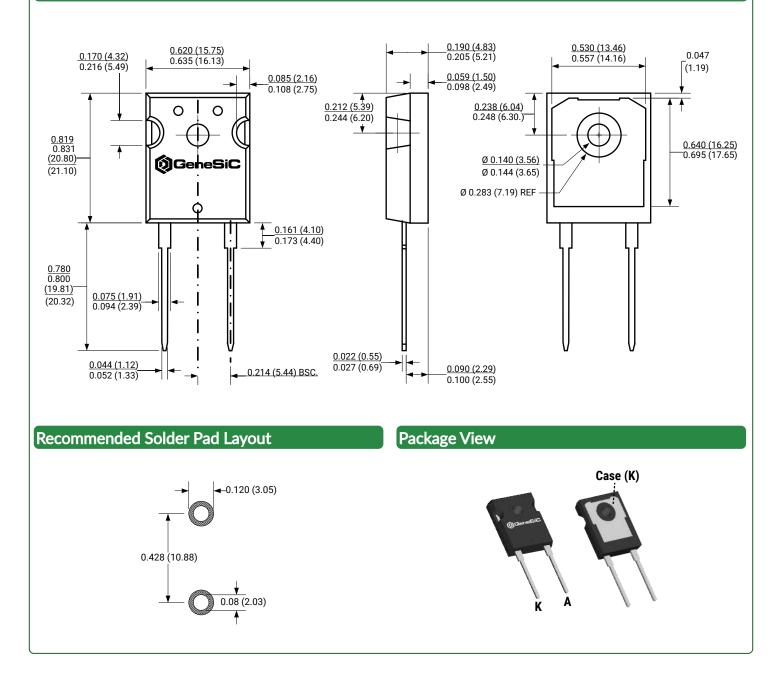
 $P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$

GD30MPS06H 650V 30A SiC Schottky MPS™ Diode



Package Dimensions

TO-247-2 Package Outline



NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.



Compliance

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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Related Links

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• Quality Manual:	https://www.genesicsemi.com/quality

Revision History								
Date	Revision	Comments	Supersedes					
Jul. 27, 2020	Rev 1	Initial Release						



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